

PROTECTION PRODUCTS - MicroClamp™

Description

The μClamp™ series of TVS arrays are designed to protect sensitive electronics from damage or latch-up due to ESD. It is designed to replace multilayer varistors (MLVs) in portable applications. It features large cross-sectional area junctions for conducting high transient currents. It offers superior electrical characteristics such as lower clamping voltage and no device degradation when compared to MLVs. They offer desirable characteristics for board level protection including fast response time, low operating and clamping voltage, and no device degradation.

The μClamp™1211P is in a 2-pin, RoHS/WEEE compliant, SLP1006P2 package. It measures 1.0 x 0.6 x 0.5mm. The leads are spaced at a pitch of 0.65mm and are finished with lead-free NiPdAu. Each device will protect one bidirectional line operating at ±12 volts. It gives the designer the flexibility to protect single lines in applications where arrays are not practical. They may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 (±15kV air, ±8kV contact discharge). The combination of small size and high ESD surge capability makes them ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Features

- ◆ Transient protection for data lines to **IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact) IEC 61000-4-4 (EFT) 40A (tp = 5/50ns) Cable Discharge Event (CDE)**
- ◆ Ultra-small package (1.0 x 0.6 x 0.5mm)
- ◆ Protects one I/O or power line
- ◆ Low clamping voltage
- ◆ Working voltage: ±12V
- ◆ Low leakage current
- ◆ Solid-state silicon-avalanche technology

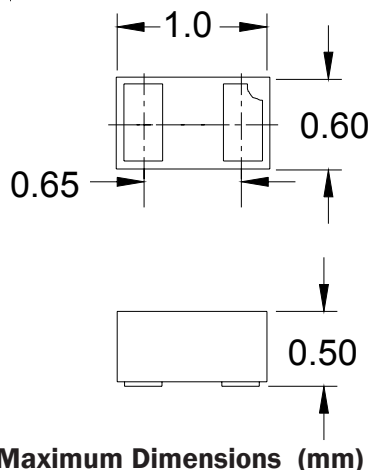
Mechanical Characteristics

- ◆ SLP1006P2 package
- ◆ Molding compound flammability rating: UL 94V-0
- ◆ Marking : Marking code
- ◆ Packaging : Tape and Reel
- ◆ Lead Finish: NiPdAu
- ◆ RoHS/WEEE Compliant

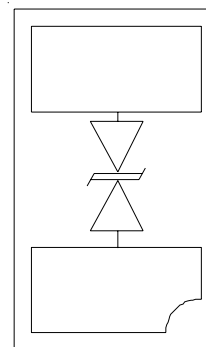
Applications

- ◆ Cellular Handsets & Accessories
- ◆ Cordless Phones
- ◆ Personal Digital Assistants (PDAs)
- ◆ Notebooks & Handhelds
- ◆ Portable Instrumentation
- ◆ Digital Cameras
- ◆ Peripherals
- ◆ MP3 Players

Dimensions



Schematic & PIN Configuration



SLP1006P2 (Bottom View)

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Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power ($t_p = 8/20\mu s$)	P_{pk}	200	Watts
Peak Pulse Current ($t_p = 8/20\mu s$)	I_{pp}	7	Amps
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V_{ESD}	± 15 ± 8	kV
Operating Temperature	T_j	-55 to +125	°C
Storage Temperature	T_{STG}	-55 to +150	°C

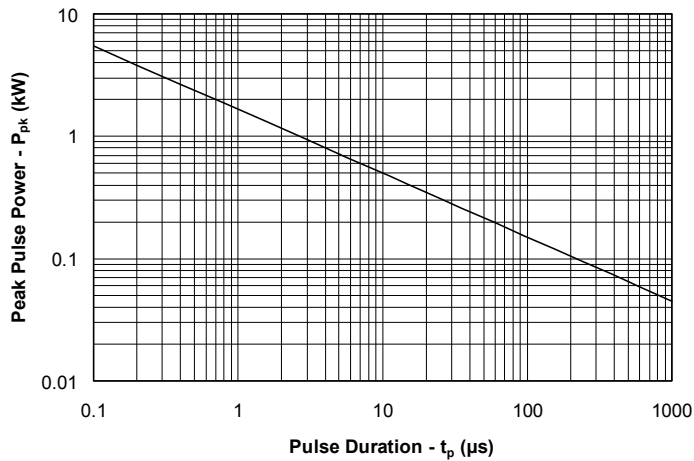
Electrical Characteristics (T=25°C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V_{RWM}				12	V
Reverse Breakdown Voltage	V_{BR}	$I_t = 1mA$	13.3			V
Reverse Leakage Current	I_R	$V_{RWM} = 12V, T=25^\circ C$			1	μA
Clamping Voltage	V_C	$I_{PP} = 1A, t_p = 8/20\mu s$			19	V
Clamping Voltage	V_C	$I_{PP} = 7A, t_p = 8/20\mu s$			28.5	V
Junction Capacitance	C_j	$V_R = 0V, f = 1MHz$			25	pF

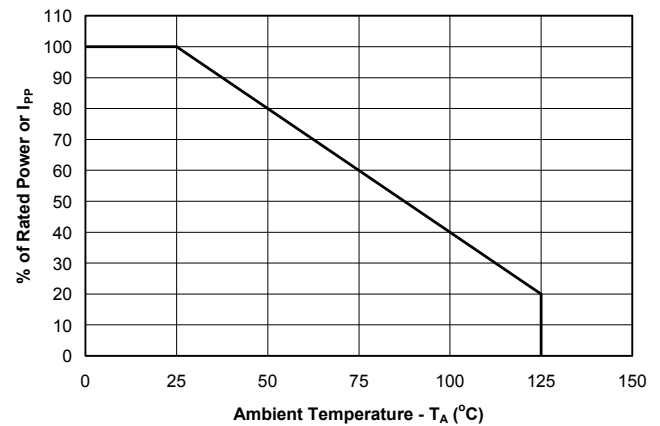
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Typical Characteristics

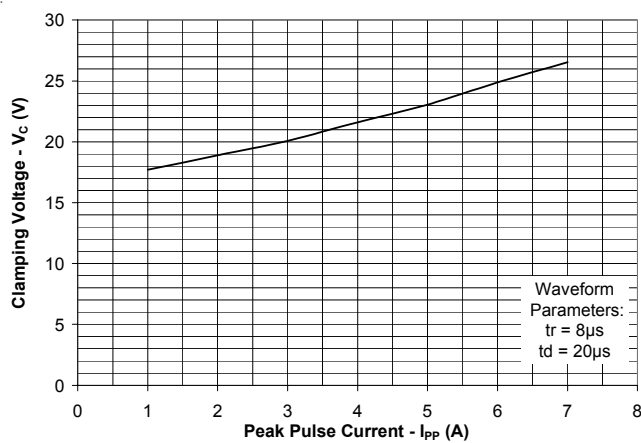
Non-Repetitive Peak Pulse Power vs. Pulse Time



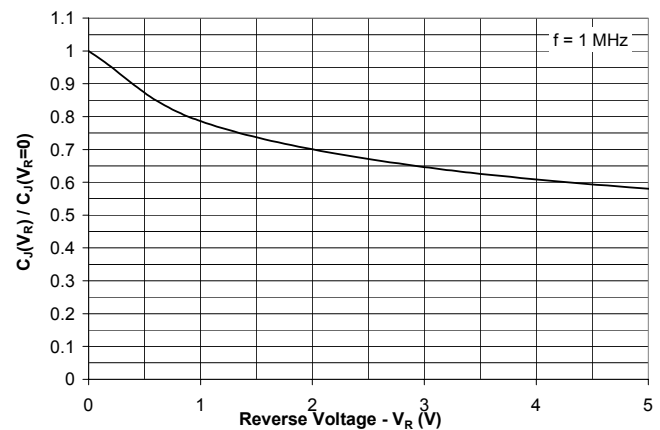
Power Derating Curve



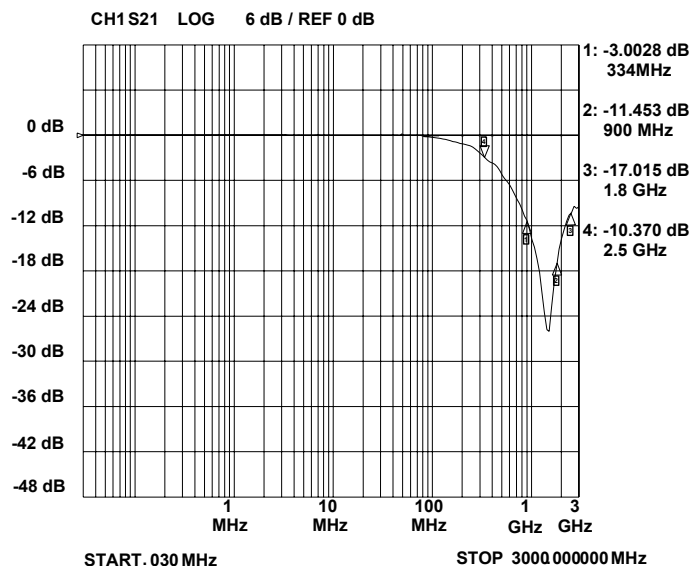
Clamping Voltage vs. Peak Pulse Current



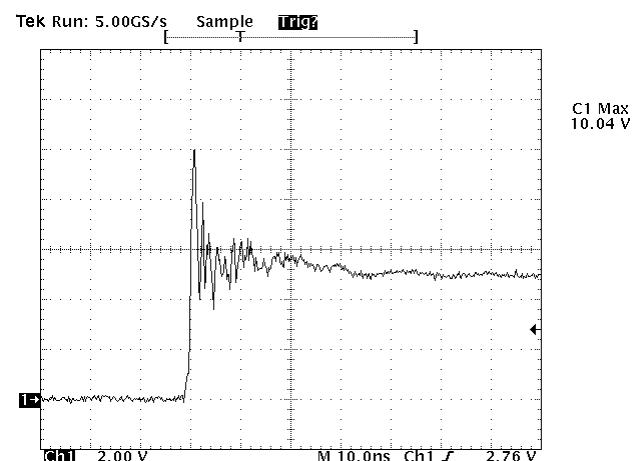
Normalized Junction Capacitance vs. Reverse Voltage



Insertion Loss (S21)



ESD Clamping
(8kV Contact per IEC 61000-4-2)



Note: Data is taken with a 10x attenuator

PROTECTION PRODUCTS**Applications Information****Device Connection Options**

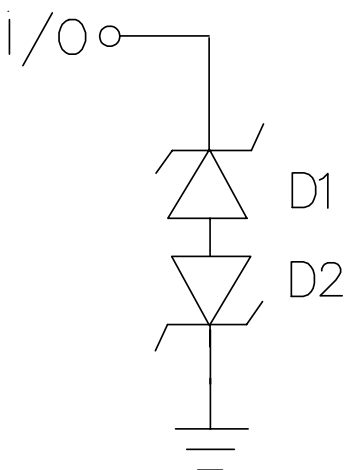
This TVS diode is designed to protect one data, I/O, or power supply line. The device is bidirectional and may be used on lines where the signal polarity can go above and below ground. The device is symmetrical, and therefore, the orientation of the device is not critical.

Circuit Board Layout Recommendations for Suppression of ESD.

Good circuit board layout is critical for the suppression of ESD induced transients. The following guidelines are recommended:

- Place the TVS near the input terminals or connectors to restrict transient coupling.
- Minimize the path length between the TVS and the protected line.
- Minimize all conductive loops including power and ground loops.
- The ESD transient return path to ground should be kept as short as possible.
- Never run critical signals near board edges.
- Use ground planes whenever possible.

Circuit Diagram

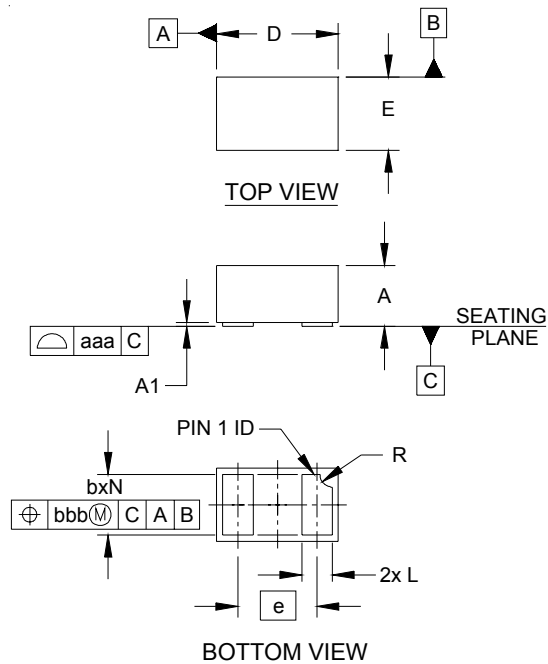


uClamp1211P Spice Model

Table 1 - μ Clamp1211P Spice Parameters			
Parameter	Unit	D1 (TVS)	D2 (TVS)
IS	Amp	1.48E-14	1.48E-14
BV	Volt	15.5	15.5
VJ	Volt	0.7	0.7
RS	Ohm	0.721	0.721
IBV	Amp	1E-3	1E-3
CJO	Farad	10E-12	10E-12
TT	sec	2.541E-9	2.541E-9
M	--	0.201	0.201
N	--	1.1	1.1
EG	eV	1.11	1.11

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Outline Drawing - SLP1006P2

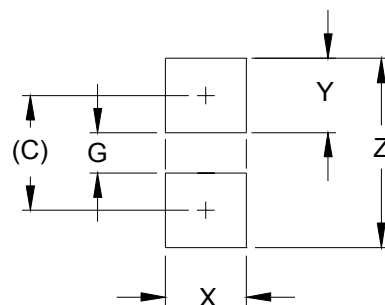


DIM	INCHES			MILLIMETERS		
	MIN	NOM	MAX	MIN	NOM	MAX
A	.016	.020	.022	0.40	0.50	0.55
A1	.000	.001	.002	0.00	0.03	0.05
b	.018	.020	.022	0.45	0.50	0.55
D	.035	.039	.043	0.90	1.00	1.10
E	.020	.024	.028	0.50	0.60	0.70
e	.026 BSC			0.65 BSC		
L	.008	.010	.012	0.20	0.25	0.30
R	.002	.004	.006	0.05	0.10	0.15
N	2			2		
aaa	.003			0.08		
bbb	.004			0.10		

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).

Land Pattern - SLP1006P2



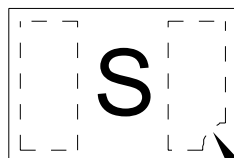
DIM	DIMENSIONS	
	INCHES	MILLIMETERS
C	(.033)	(0.85)
G	.012	0.30
X	.024	0.60
Y	.022	0.55
Z	.055	1.40

NOTES:

1. CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES).
2. THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY.
CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR
COMPANY'S MANUFACTURING GUIDELINES ARE MET.

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Marking Code



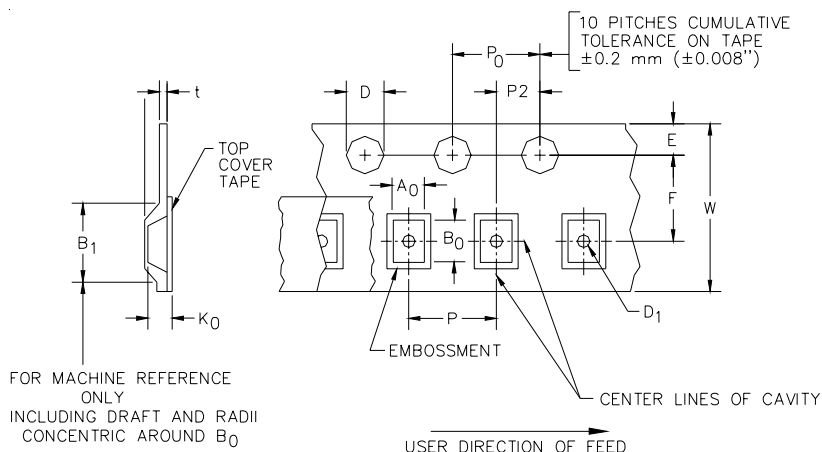
PIN 1 ID

Ordering Information

Part Number	Working Voltage	Device Marking	Qty per Reel	Reel Size
uClamp1211P.TCT	12V	S	3,000	7 Inch

MicroClamp, uClamp and μ Clamp are marks of Semtech Corporation

Tape and Reel Specification



A0	B0	K0
0.69 $\pm$ 0.10 mm	1.19 $\pm$ 0.10 mm	0.66 $\pm$ 0.10 mm

Tape Width	B, (Max)	D	D1	E	F	P	P0	P2	T	W
8 mm	4.2 mm (.165)	1.5 $\pm$ 0.1 mm - 0.0 mm (0.59 $\pm$.005 - .000)	0.4 mm $\pm$ 0.25 (.031)	1.750 $\pm$.10 mm (.069 $\pm$.004)	3.5 $\pm$ 0.05 mm (.138 $\pm$.002)	4.0 $\pm$ 0.10 mm (.157 $\pm$.004)	4.0 $\pm$ 0.1 mm (.157 $\pm$.004)	2.0 $\pm$ 0.05 mm (.079 $\pm$.002)	0.254 $\pm$ 0.02 mm (.016)	8.0 mm + 0.3 mm - 0.1 mm (.312 $\pm$.012)

Contact Information for Semtech International AG

Taiwan Branch
Tel: 886-2-2748-3380
Fax: 886-2-2748-3390

Korea Branch
Tel: 82-2-527-4377
Fax: 82-2-527-4376

Shanghai Office
Tel: 86-21-6391-0830
Fax: 86-21-6391-0831

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Semtech Switzerland GmbH
Japan Branch
Tel: 81-3-6408-0950
Fax: 81-3-6408-0951

Semtech Limited (U.K.)
Tel: 44-1794-527-600
Fax: 44-1794-527-601

Semtech France SARL
Tel: 33-(0)169-28-22-00
Fax: 33-(0)169-28-12-98

Semtech Germany GmbH
Tel: 49-(0)8161-140-123
Fax: 49-(0)8161-140-124